

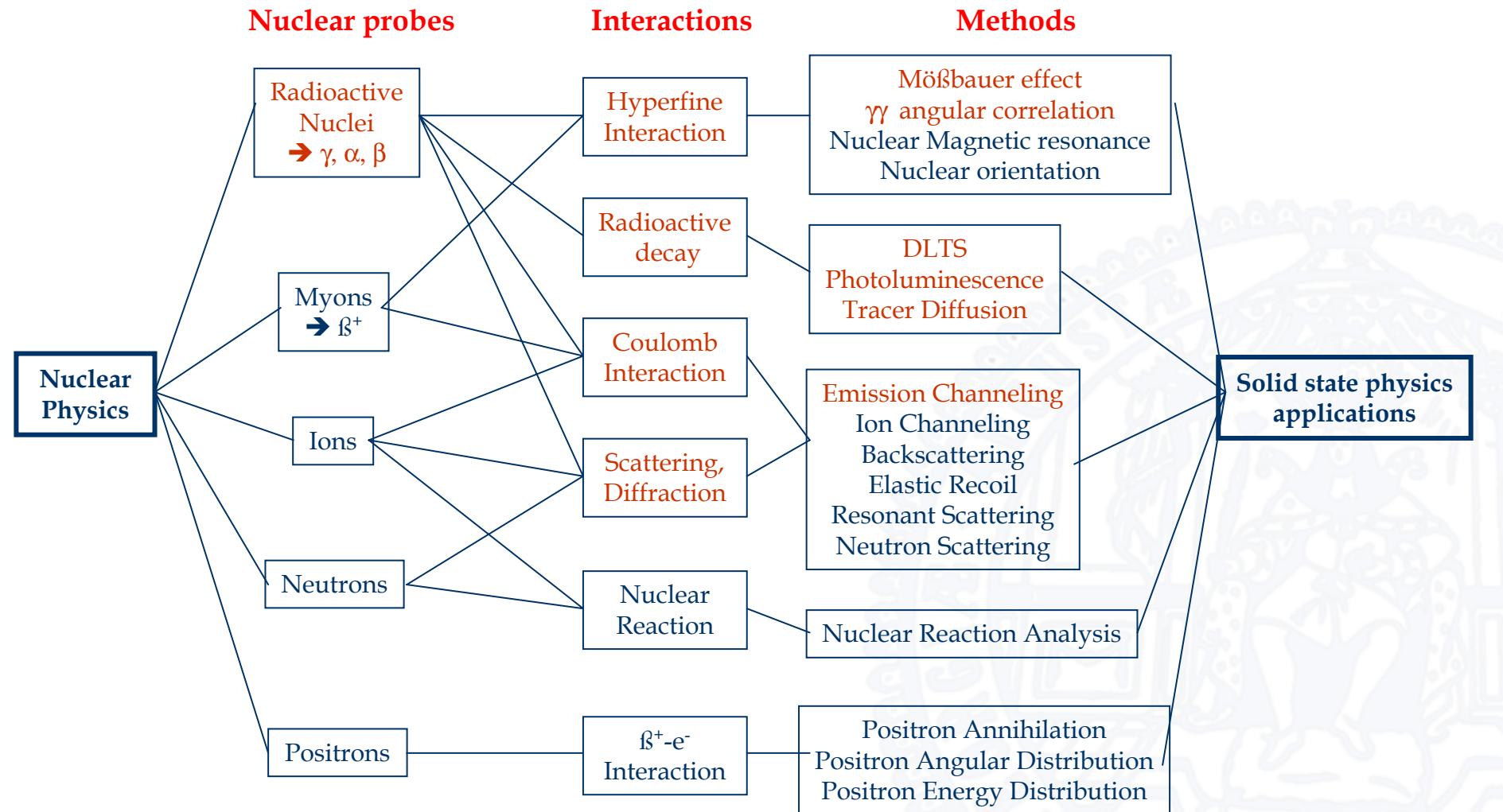
# New developments in solid state physics using radioactive ions

A survey by H. Hofsäss

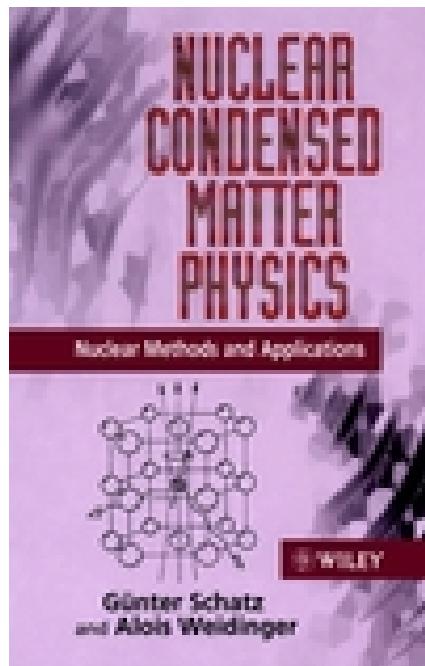
## Outline

- Radioactive ion beams for condensed matter physics
- Recent technical and methodical developments
- Possible areas of research (sorted by method):
  - Time Dependant Perturbed Angular Correlation (TDPAC), Mössbauer spectroscopy (MS)
  - Emission channeling (EC)
  - Photo- and Cathodoluminescence (PL/CL), Deep Level Transient Spectroscopy (DLTS)
- Selected examples
  - Phase identification, phase transitions, new phases
  - Diluted magnetic semiconductors , magnetic thin films,
  - High k dielectric materials, optoelectronic materials, photovoltaic materials
  - charge storage materials, diffusion phenomena
- Summary

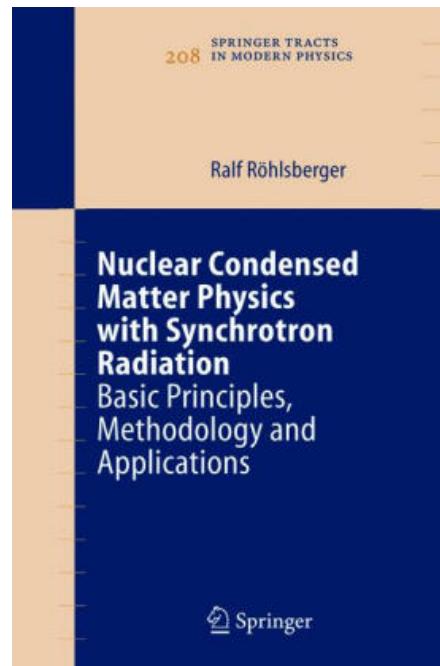
# RIB solid state physics as applied nuclear physics



## Textbooks and Reports



ISBN: 0-471-95479-9  
Wiley, January 1996

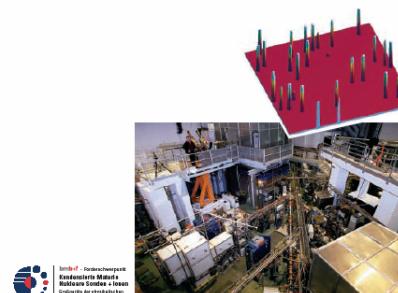


ISBN: 3-540-23244-3  
Series : Springer Tracts  
in Modern Physics ,  
Vol. 208 , 2005

Komitee für Forschung mit nuklearen Sonden und Ionenstrahlen

Erforschung kondensierter  
Materie mit nuklearen  
Sonden und Ionenstrahlen  
an Großforschungsanlagen  
in Deutschland

Status und Perspektiven



ISBN 3-00-011643-5  
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Druck und Satz,  
Berlin, 2003

## Some recent review articles

**Nuclear probes in life sciences**, W. Tröger,

Fakultät für Physik und Geowissenschaften, Universität Leipzig, Germany

Hyperfine Interactions, 120-121 (1999) 117 - 128

**A future for nuclear analytical techniques? Why not?** P. Bode,

Interfaculty Reactor Institute, Delft University of Technology, Delft, The Netherlands

Analytical and Bioanalytical Chemistry 379 (2004) 181 - 187

**Nuclear Resonant Scattering into the New Millennium**, R. Rüffer,

European Synchrotron Radiation Facility (ESRF), Grenoble, France

Hyperfine Interactions 141-142 (2002) 83 - 97

**Radioactive isotopes in solid state Physics**, M. Deicher,

*Fachbereich Physik, Universität Konstanz, Konstanz, Germany*

Europhysics News (2002) Vol. 33

**Project Research on the Condensed Matter with Short-Lived Nuclei**, M. Seto

Progress report 2002, Materials Science and Radiation effects,

Kyoto University, Research Reactor Institute.

**Studies of semiconductors**

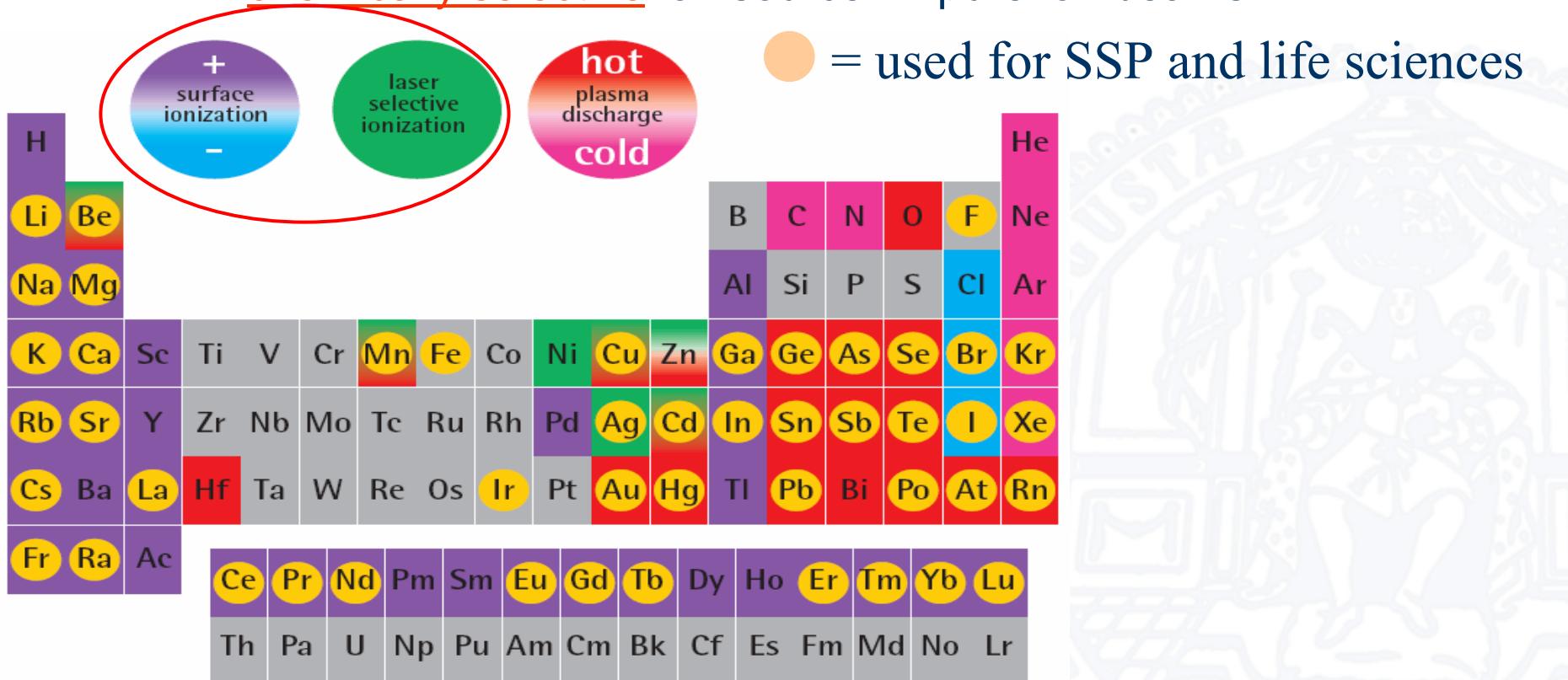
Th. Wichert, M. Deicher,

Technische Physik, Universität des Saarlandes, Saarbrücken, Germany),

Nuclear Physics A693, 2001, 327-357.

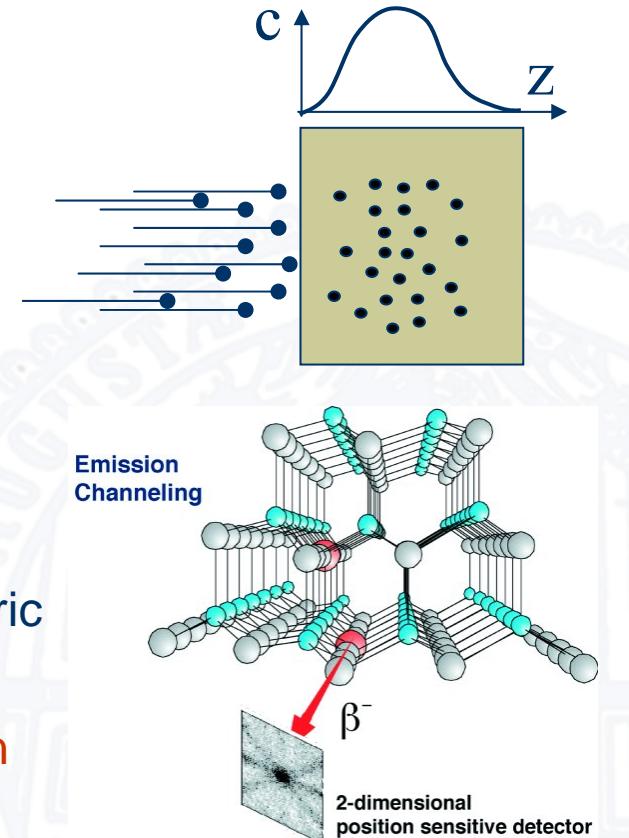
# Unique features of radioactive probe atoms and radioactive ion beams

- Large variety of isotopes available at ISOLDE
  - chemically selective ion source → pure ion beams



## Unique features of radioactive probe atoms for SSP applications

- Chemically selective and isotope specific
- Extremely good detection limit
  - among the most sensitive methods, no reaction cross section limitation
    - $10^{15} - 10^{18}$  probes/cm<sup>3</sup>
    - $10^{11} - 10^{12}$  probe atoms
- Depth distribution and concentration control
  - Ion energy and ion fluence control
  - Circumventing solubility and diffusion limits
- Highly local Information
  - Nucleus-size sensors for **local** magnetic and electric fields  
Electric Field Gradient  $\sim r^{-3}$
  - Emission channeling:  $\sim 0.02$  nm position resolution



**Why radioactive probes ? Sensitive – Selective - Controllable - Local**

## Recent technical and methodical developments

**TDPAC:** Improved efficiency and time resolution,  
compensation for multiplier drift

- **LYSCO and LUAP Scintillators**: efficient detectors for TDPAC gammas, Efficiency comparable to NaJ, Timing < 1ns, energy resolution 7%, chemically robust
- **Fast Digitizer cards**: 1-5 GS/s, real time data analysis

**EC:** Efficient decay electron imaging

- Position sensitive PAD detectors
- Position sensitive CCD sensors, high count rate (> 10 kHz) , low noise, high energy resolution (< 3 keV)

**PL/CL:** Efficient PL/CL spectroscopy in the UV region

- Compact UV lasers (Diode pumped Nd:YAG, 266 nm, 8mJ/puls, 8ns)
- CCD detectors for UV an soft X-rays

## Scintillator crystals for TDPAC

(Developed for advanced PET scanners)

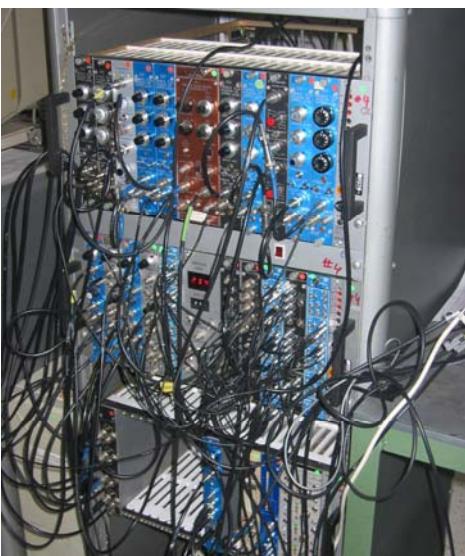
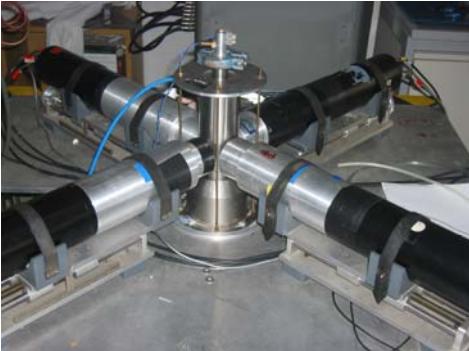


LuAP -  $\text{LuAlO}_3:\text{Ce}$   
LYSO -  $\text{Lu}_{2(1-x)}\text{Y}_{2x}\text{SiO}_5:\text{Ce}$   
(Source: Photonic materials)

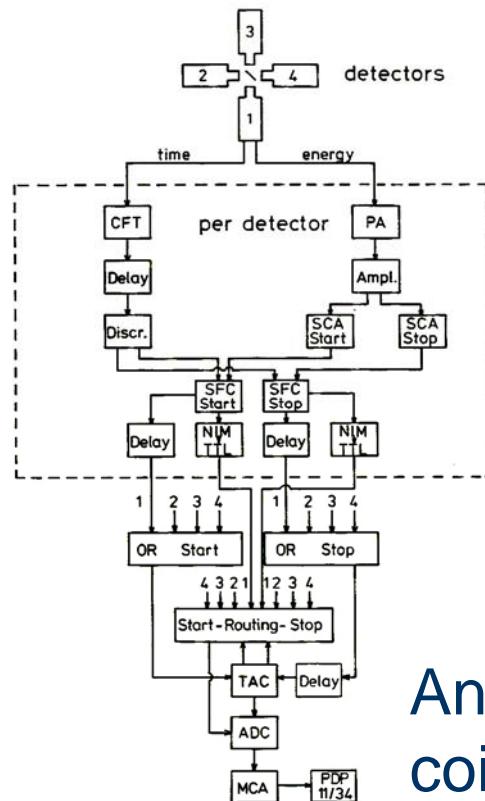
Property	LYSO	LuAP
Density	7.1 (10% Y)	8.3
$Z_{\text{eff}}$	64	66
Stopping Power	135	148
Attenuation length	1.2	1.04
Energy Resolution	~10%	7-9%
Photo Fraction	36%	30%
Light Yield	1.2	~0.5
Decay Time	~40 ns	17 ns
Physically Robust	Hard	Hard
Timing Resolution	<450ps	500ps

**Good Photoefficiency, Light yield,  
Time resolution, Energy resolution**

## Conventional TDPAC setup



Source: Univ. Göttingen



Source: Univ. Leipzig

Analog slow-fast  
coincidence scheme ...

... will be replaced by .....



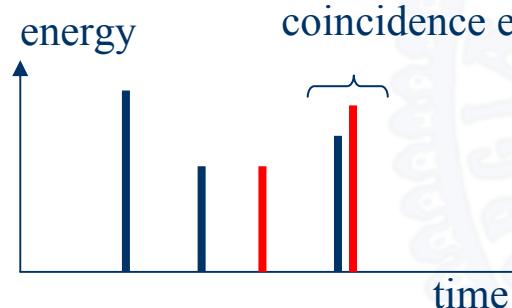
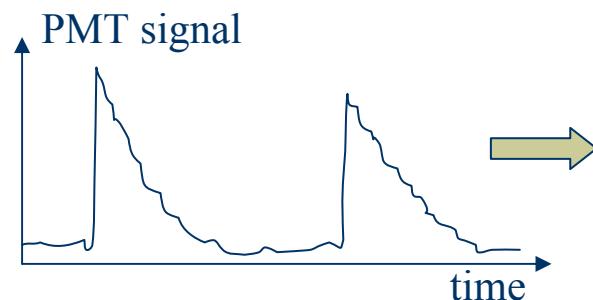
## Fast digitizer cards

Applications: RADAR, LIDAR, SATCOM, TOFMS, scanning acoustic tomography, plasma physics, gamma spectroscopy

Commercial systems:

- GaGe compuscope 82 G 2GS/s 8 bit
- GaGe compuscope 85 G 5GS/s 8 bit
- Acqiris DC222 8 GS/s 10 bit
- Acqiris SC240 2GS/s 10 bit (streamer analyzer)
- Acquitek ADC3200 2GS/s 10 bit
- Delphi 2GS/s 8 bit
- EONIC DAR 1.5 GS/s 8 bit

- Improved timing
- Reduced false coincidences
- Eliminates PMT drift
- Higher count rates

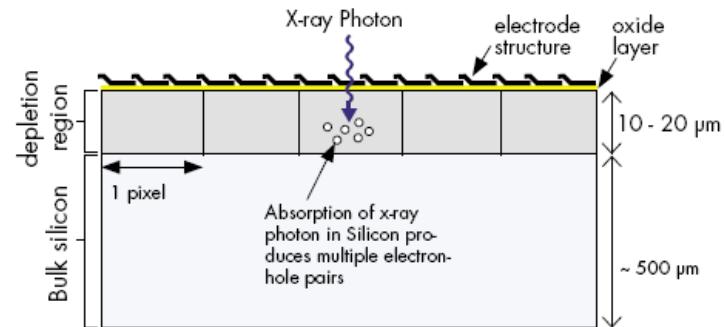


## “Blue shift” in optoelectronics - Lasers and CCD detectors for UV light

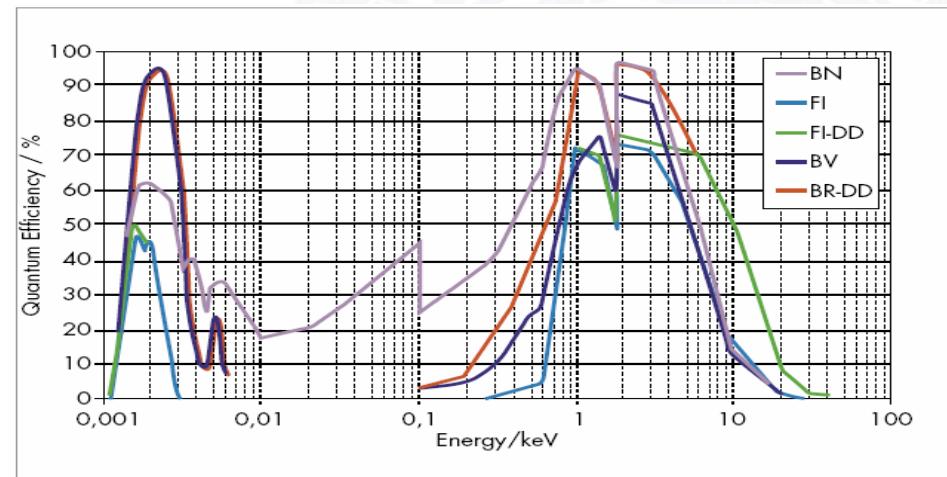
Diode-pumped, Q-switched pulsed  
Nd:YAG laser (LOT-Oriel)  
45 mJ at 1064 nm, 100 Hz in 7ns pulses  
8 mJ at **266 nm, 100Hz in 8ns pulses**



Centurion with SHG/THG module and power supply

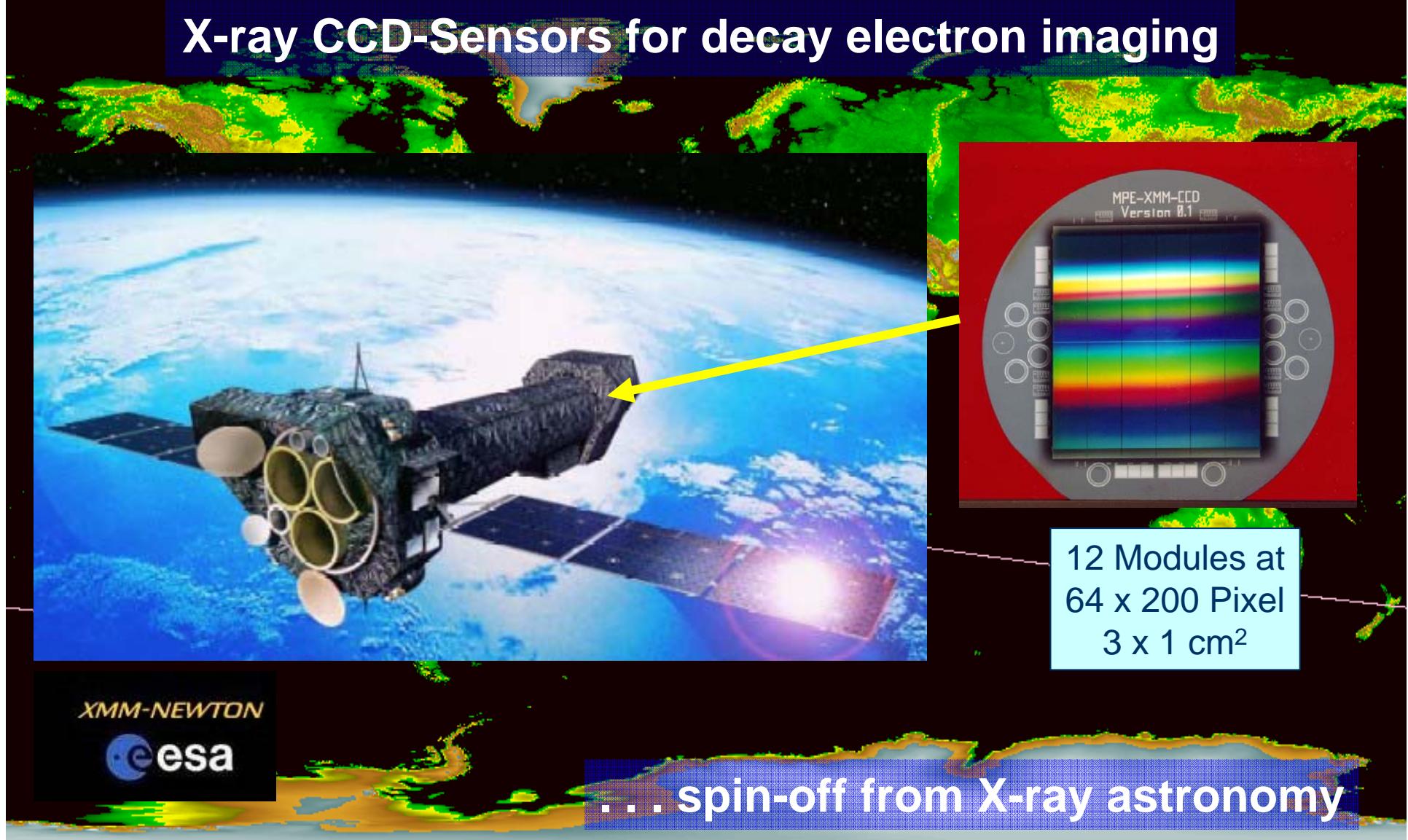


Quantum efficiency of ANDOR CCDs



### Efficient UV PL/CL studies on wide band gap materials

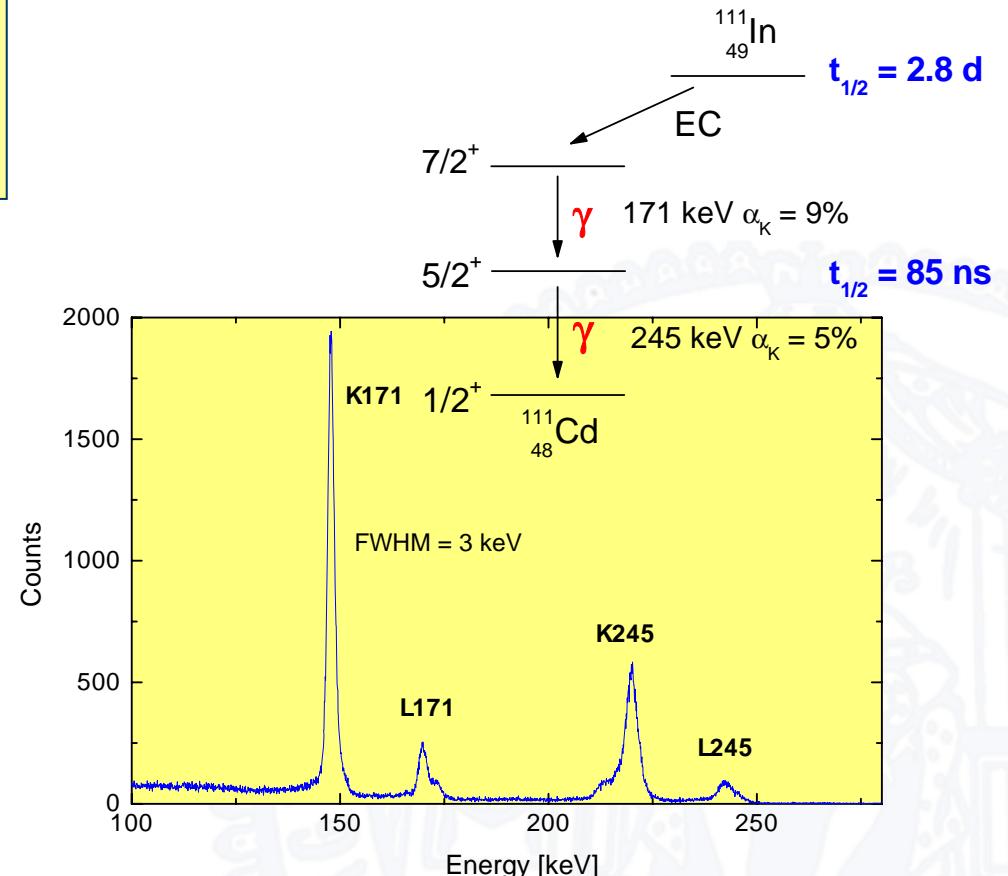
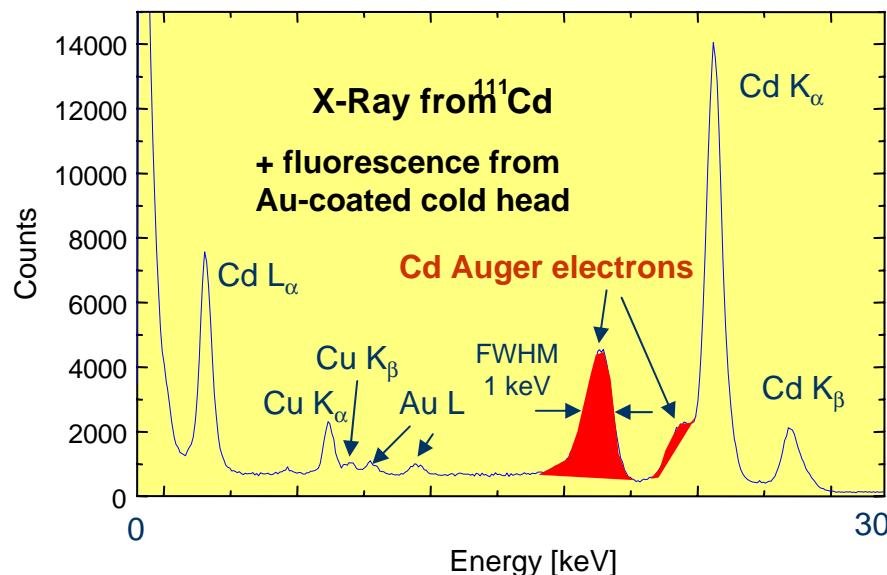
## X-ray CCD-Sensors for decay electron imaging



## X-ray CCD sensor of decay electron imaging spectroscopy

- 64 x 200 Pixel Pixel size: 150 x 150  $\mu\text{m}^2$
- 300  $\mu\text{m}$  pn-CCD from FZ-Si (5 k $\Omega\text{cm}$ )
- Noise: 5 e $^-$  ENC (180 K) ; readout: 4.5 ms

Semiconductor lab, MPI for Extra-terrestrial Physics,  
Munich



High count rate, low noise, low energies, excellent energy resolution

## Possible areas of research

### TDPAC and Mössbauer Spectroscopy

Nuclear probes as sensors inside the nanoworld

- Nanoparticles, Nanowires, nm-sized layered thin films, Nanocomposite Materials, Macromolecules
- Probe atoms at surfaces and interfaces

Nuclear probes as local magnetic field sensors

- Magnetic properties of clusters and nanocrystalline films
- Heavy fermion systems, Magnetoresistive materials
- Understanding magnetic hyperfine fields in solids

## Possible areas of research

### TDPAC and Mössbauer Spectroscopy

#### Understanding advanced materials

- Phase transitions and phase identification
- Impurity defect interactions with light ions H, Li, ...
  - Charge storage materials, Li batteries, Ultracapacitors
  - Passivation phenomena in wide band gap semiconductors
- Interface and grain boundary processes , Point defects in intermetallic compounds and alloys, radiation damage effects
- New materials as advanced thin film coatings
- Diluted magnetic semiconductors (TM:ZnO, TM:GaN)
- New high k dielectric materials ( $\text{Pr}_2\text{O}_3$ ,  $\text{HfO}_2$ , . . .)
- Ternary photovoltaic compounds

#### Life Science

- Biological and pharmaceutical tracer studies

## Possible areas of research

### Emission channeling

#### Lattice location studies in UV/VIS optoelectronic materials

- Rare earth elements in wide band gap semiconductors
  - GaN, AlN, ZnO, c-BN, diamond, SiC, sapphire
- Rare earth elements and other color center impurities in Quartz
  - Utilize epitaxial recrystallization of quartz
- Dopant atoms in cubic boron nitride (the “forgotten” III-V semiconductor)

#### Lattice location and defect interaction of light impurities, Li, Na, ..

- Li diffusion in charge storage materials
- Li diffusion in some wide band gap semiconductors

#### Lattice location studies in diluted magnetic semiconductors

- Mn doped ZnO and GaN

#### Lattice location studies in combination with Mössbauer spectroscopy

- Crystalline thin film materials

#### Towards lattice location of atoms near surfaces

## Possible areas of research

### PL/CL Spectroscopy of semiconductor materials

#### UV/VIS optoelectronic materials

- Energy levels of impurity centers
- Annealing of implantation damage
- Transmutation doping studies
- Investigation of Antisite defects, DX centers

### DLTS Spectroscopy of semiconductor materials

#### Detecting deep levels - “the dark matter of semiconductors”

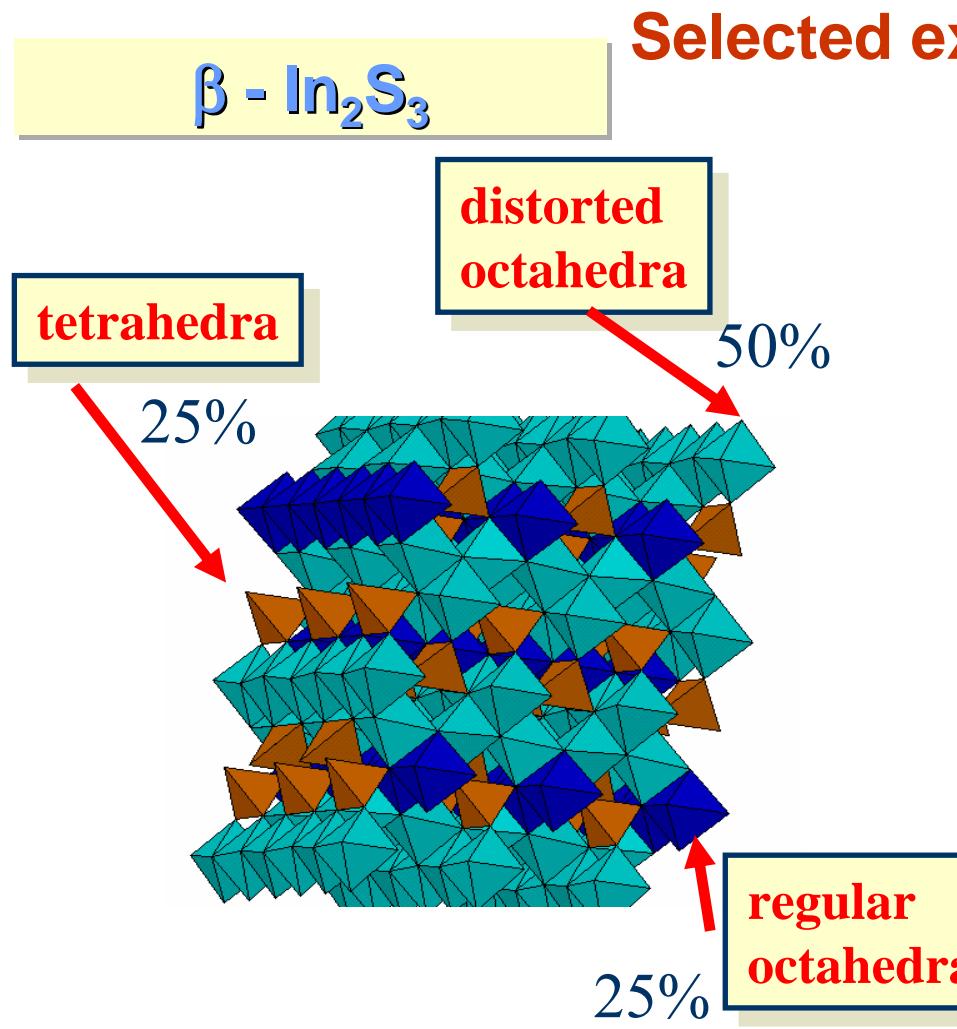
- Identification of deep level centers
- Measuring energy levels
- Correlation to charge carrier lifetimes

### Tracer diffusion

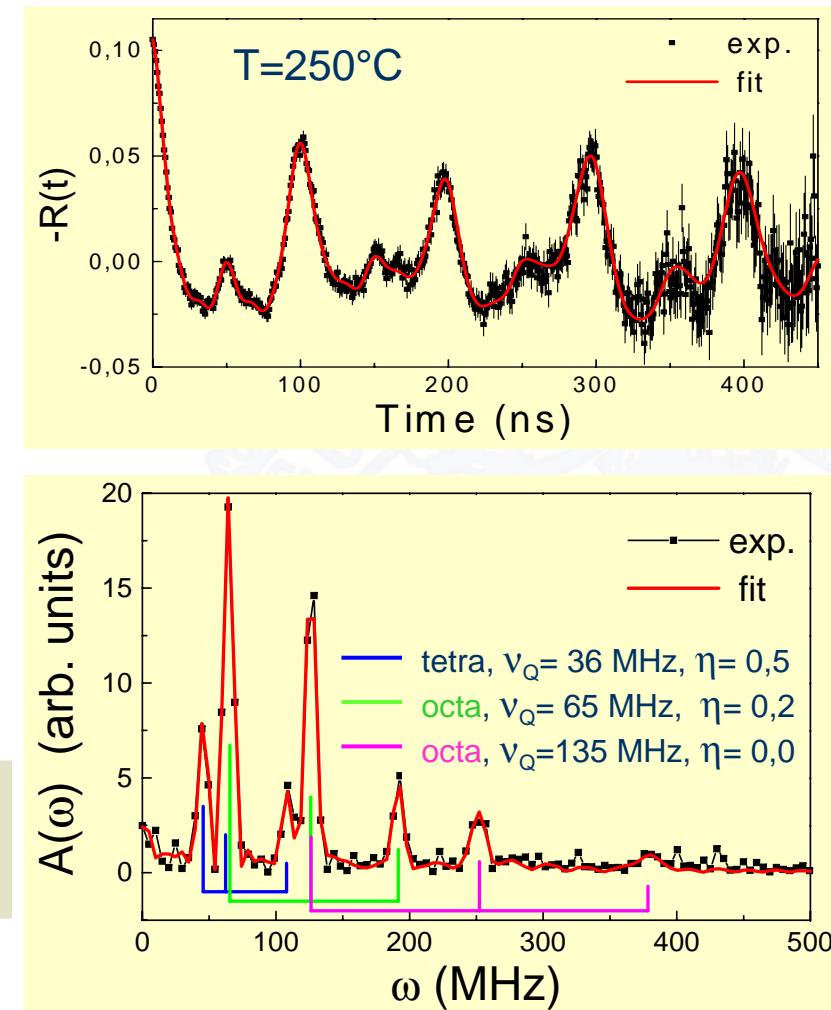
Still the most sensitive and most specific way to study diffusion processes

## Selected examples

- **Phases and phase transitions in compounds systems:**  
 $\text{In}_2\text{S}_3$  : a candidate as Li storage material
- **Tracing local environments in complex materials:**  
Phase transition in Mn-oxide
- **Tracing magnetic textures without external B-fields:**  
applications for TDPAC and Mössbauer studies
- **MAX Phases:** even more complex future materials; a playground for TDPAC and Mössbauer studies
- **High k dielectric materials**
- **Diluted magnetic semiconductors:**  
Lattice location studies as a key to the local microstructure

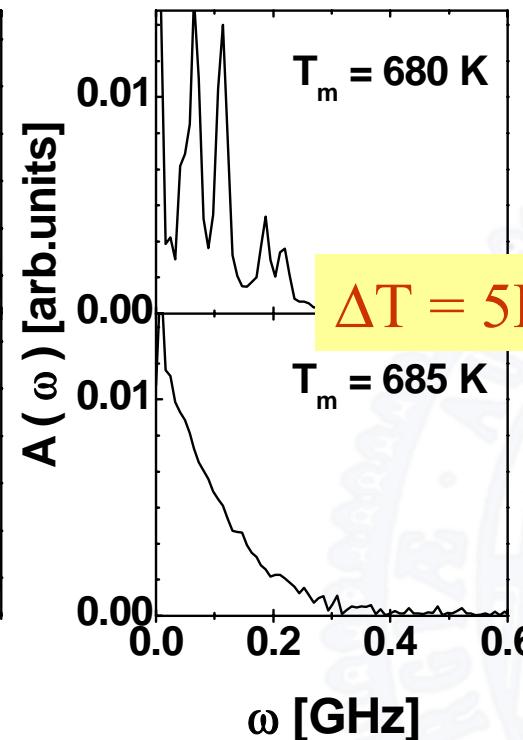
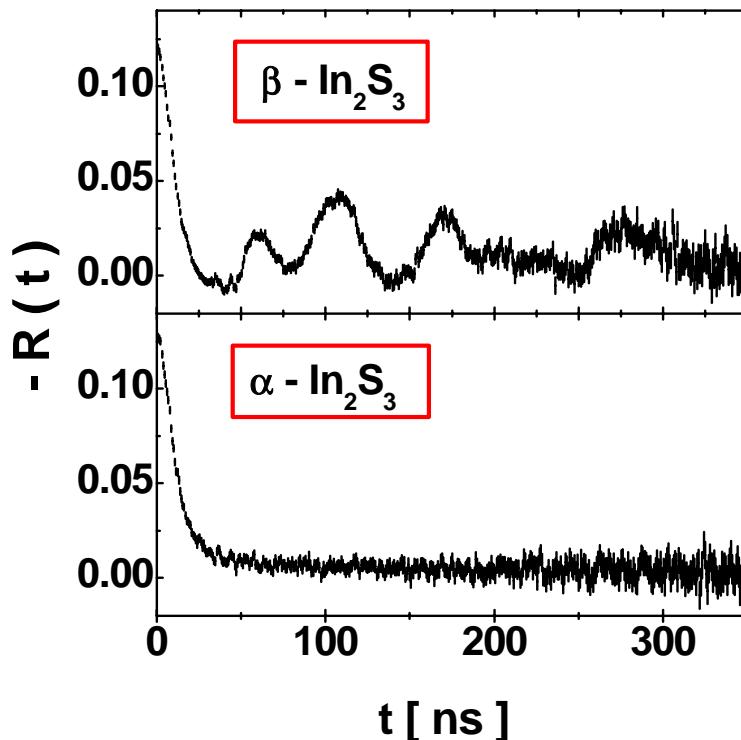


L. Aldon, et al., *Phys. Rev. B*, 58 (1998) 11303



## Selected examples

### $\beta \rightarrow \alpha$ Phase Transition in $\text{In}_2\text{S}_3$



Kulinska et al., J. Sol. State Chem. 177 (2004) 109

L. Aldon, et al., Phys. Rev. B, 58 (1998) 11303

## Selected examples

### Li doped $\text{In}_2\text{S}_3$ with mobile Li atoms

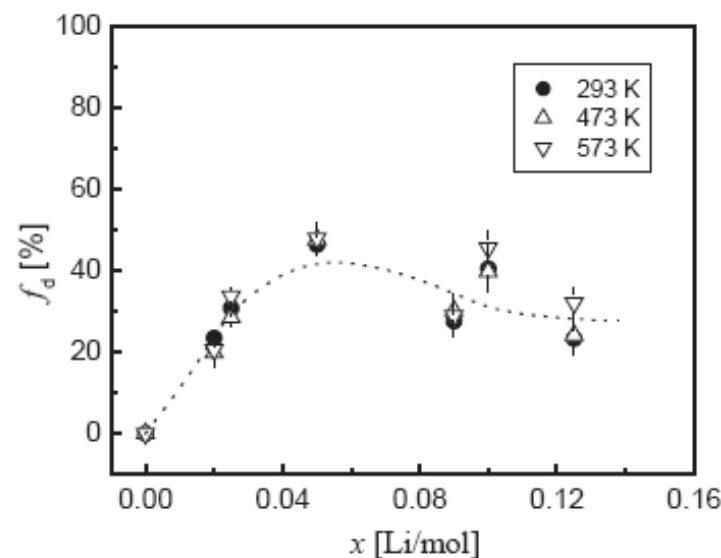


Fig. 6. The change of the dynamic fraction  $f_d$  with the Li content  $x$  in  $\text{Li}_x\text{In}_2\text{S}_3$ .

Kulinska et al., J. Sol. State Chem. 177 (2004) 109

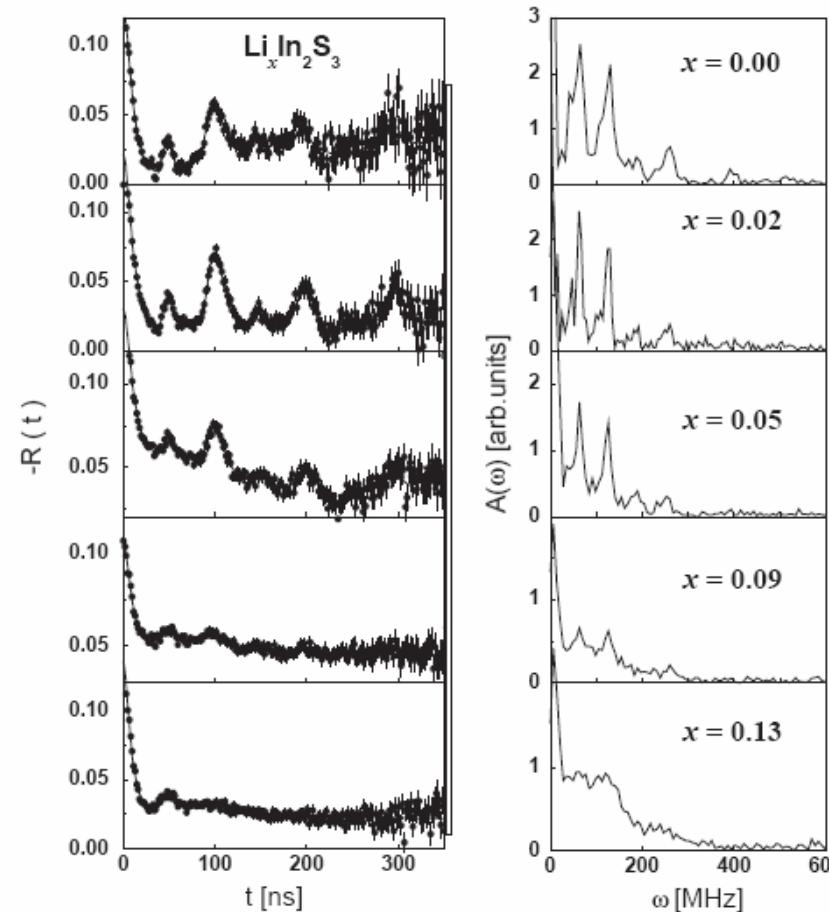
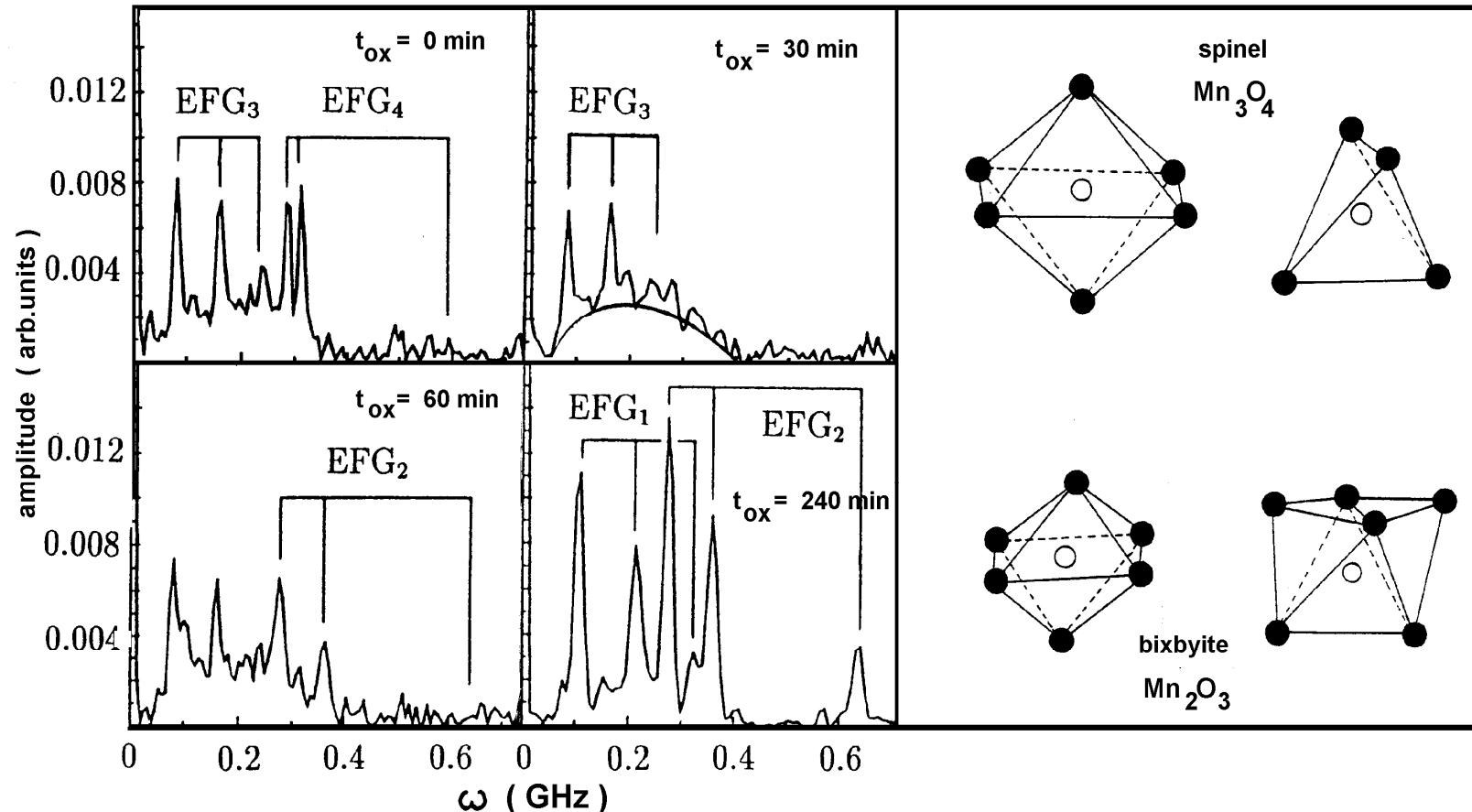


Fig. 4. PAC patterns and Fourier transforms taken at  $T_m = 473\text{ K}$  for  $^{113}\text{Cd}$  in  $\text{Li}_x\text{In}_2\text{S}_3$  for different Li contents  $x$ .

C<sub>Li</sub>

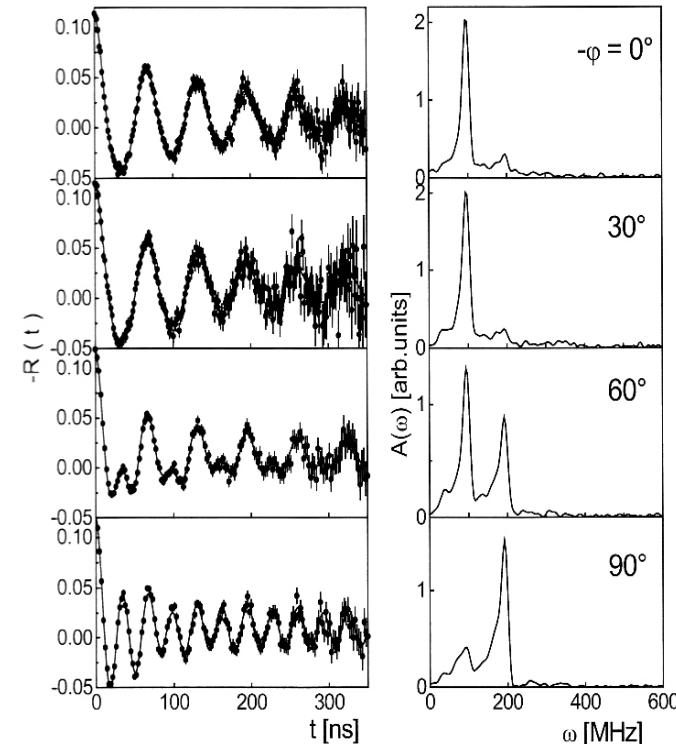
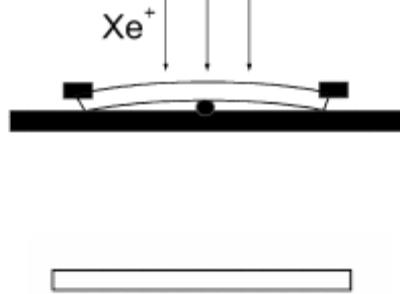
## Selected examples

structural phase transition:  $\text{Mn}_3\text{O}_4 \rightarrow \text{Mn}_2\text{O}_3$

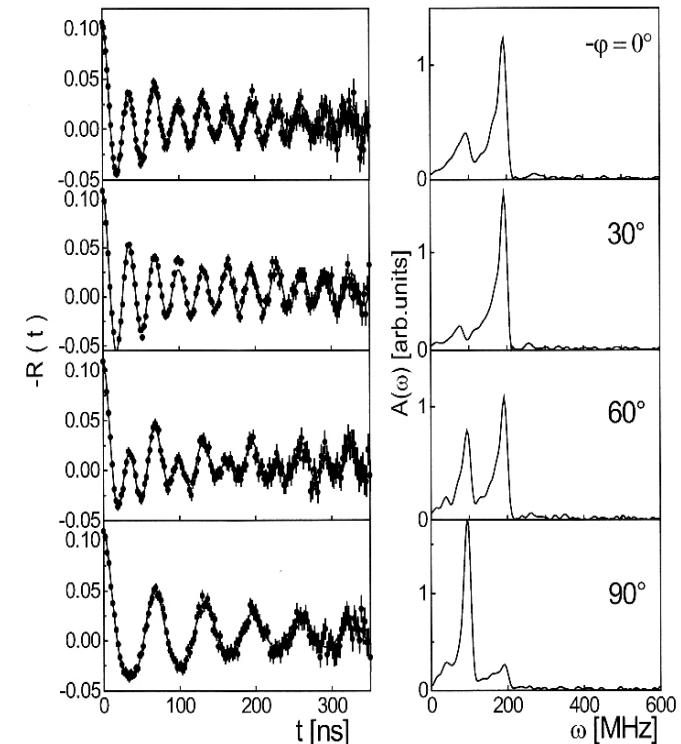


## Selected examples

change of the magnetic texture in Ni seen by TDDPAC



Xe-irradiated and bent film

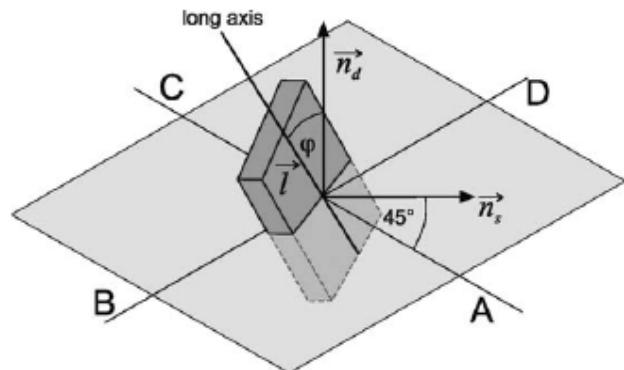


Relaxed film

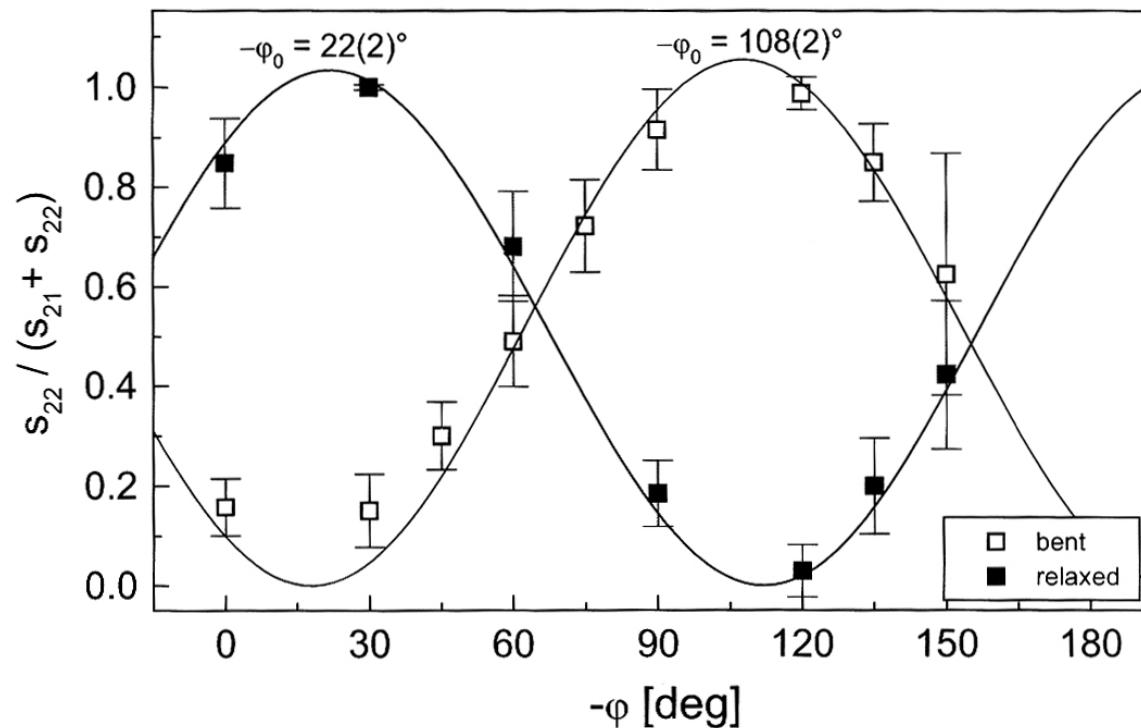
G.A.Müller, et al., Hyp.Int.151/152(2003)223

## Selected examples

change of the magnetic texture in Ni seen by TDPAC



In-plane magnetic texture rotates after relaxation

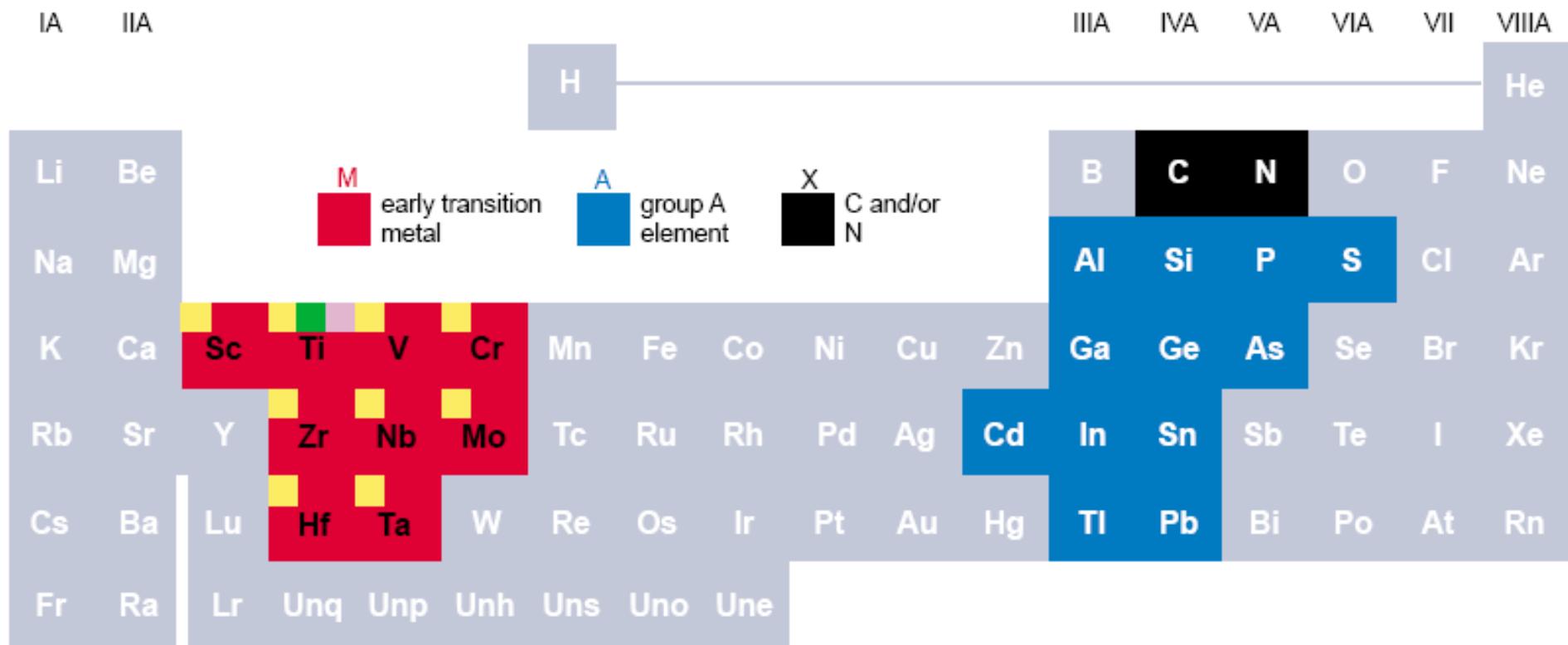


G.A.Müller, et al., Hyp.Int.151/152(2003)223

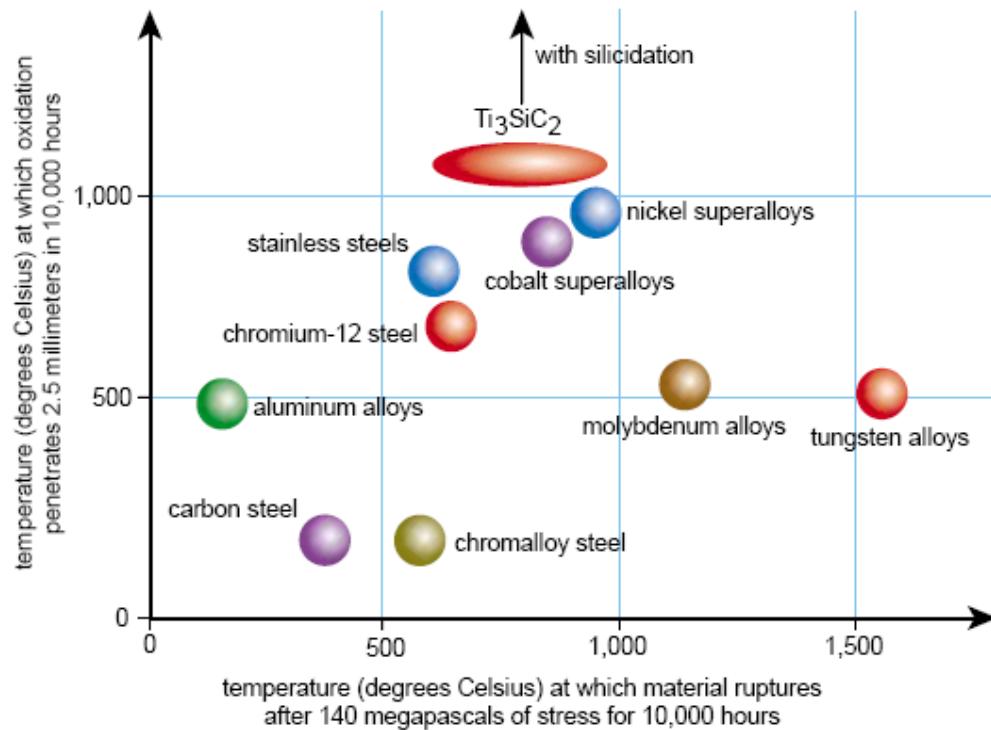
## Selected examples

### MAX phases, unique carbide and nitride materials

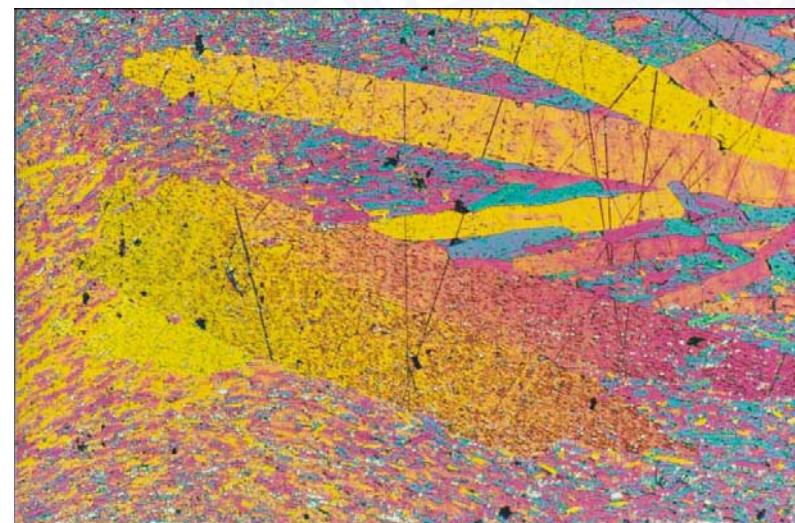
Michel W. Barsoum and Tamer El-Raghy, American Scientist 89 (2001) 334



## Selected examples



- oxidation resistant
- high mechanical strength
- highly conductive
- superior to other metal alloys



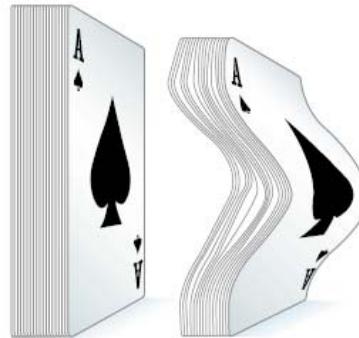
Optical micrograph

Figure 2. Materials in demanding applications not only must retain their strength, but also need to resist oxidation. The chart shows how some of the most important high-performance alloys stack up against titanium silicon carbide, Ti<sub>3</sub>SiC<sub>2</sub>. Materials toward the right resist breakage under stress at high temperatures; materials toward the top can reach high temperatures before oxidation attacks the material surface. Titanium silicon carbide exceeds all current materials for oxidation resistance and approaches the nickel superalloys in strength.

## Selected examples

**211**

Ti <sub>2</sub> AIC*	Ti <sub>2</sub> AlN*	Hf <sub>2</sub> PbC*	Cr <sub>2</sub> GaC	V <sub>2</sub> AsC	Ti <sub>2</sub> InN
Nb <sub>2</sub> AIC*	(Nb,Ti) <sub>2</sub> AIC*	Ti <sub>2</sub> AlN <sub>0.5</sub> C <sub>0.5</sub> *	Nb <sub>2</sub> GaC	Nb <sub>2</sub> AsC	Zr <sub>2</sub> InN
Ti <sub>2</sub> GeC*	Cr <sub>2</sub> AIC	Zr <sub>2</sub> SC	Mo <sub>2</sub> GaC	Ti <sub>2</sub> CdC	Hf <sub>2</sub> InN
Zr <sub>2</sub> SnC*	Ta <sub>2</sub> AIC	Ti <sub>2</sub> SC	Ta <sub>2</sub> GaC*	Sc <sub>2</sub> InC	Hf <sub>2</sub> SnN
Hf <sub>2</sub> SnC*	V <sub>2</sub> AIC	Nb <sub>2</sub> SC	Ti <sub>2</sub> GaN	Ti <sub>2</sub> InC	Ti <sub>2</sub> TiC
Ti <sub>2</sub> SnC*	V <sub>2</sub> PC	Hf <sub>2</sub> SC	Cr <sub>2</sub> GaN	Zr <sub>2</sub> InC	Zr <sub>2</sub> TiC
Nb <sub>2</sub> SnC*	Nb <sub>2</sub> PC	Ti <sub>2</sub> GaC	V <sub>2</sub> GaN	Nb <sub>2</sub> InC	Hf <sub>2</sub> TiC
Zr <sub>2</sub> PbC*	Ti <sub>2</sub> PbC*	V <sub>2</sub> GaC	V <sub>2</sub> GeC	Hf <sub>2</sub> InC	Zr <sub>2</sub> TiN



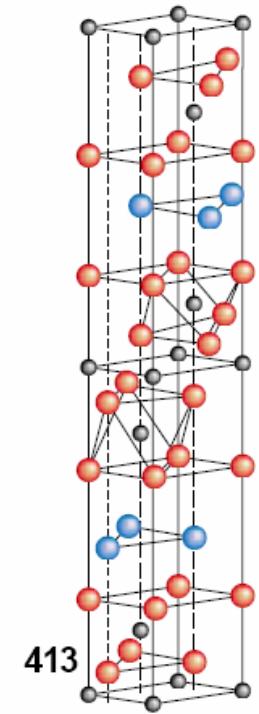
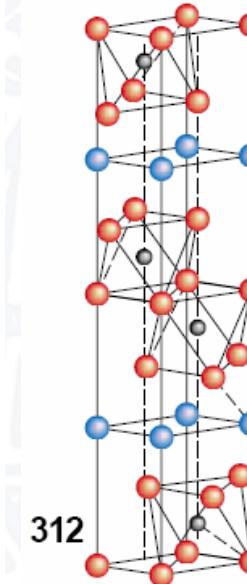
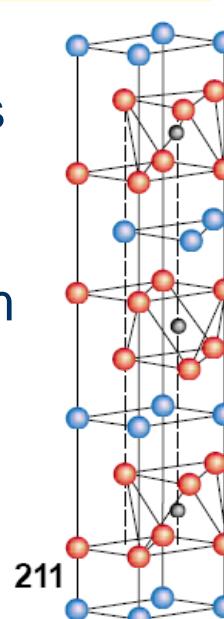
- more than 50 compounds need to be explored
- Challenge to grow thin film coatings
- In, Hf and Sn suitable as local probes for TDPAC and MS studies

**312**

Ti <sub>3</sub> AIC <sub>2</sub> *	Ti <sub>3</sub> GeC <sub>2</sub> *
Ti <sub>3</sub> SiC <sub>2</sub> *	

**413**

Ti <sub>4</sub> AlN <sub>3</sub> *
------------------------------------



## Selected examples

### High k dielectrics on Si: $\text{Pr}_2\text{O}_3$ , $\text{TaO}_x$ , $\text{HfO}_2$ , $\text{TiO}_2$

#### High k gate dielectrics are required for the sub-100 nm MOS structures

- Conventional  $\text{SiO}_2$  too thin (e.g. 2 nm) to minimize tunneling currents and out diffusion of boron from the gate.
- A thick layer can be used with high k material to lower the parasitic capacitance between gate and source (drain).

#### Three types of high k dielectrics:

1.  $4 < k < 10$  such as  $\text{SiN}_x$ ;
2.  **$10 < k < 100$  such as  $\text{Ta}_2\text{O}_5$ ,  $\text{Al}_2\text{O}_3$ , and  $\text{TiO}_2$ ,  $\text{HfO}_2$ ,  $\text{Pr}_2\text{O}_3$ , ...**
3.  $100 < k$  such as PZT.

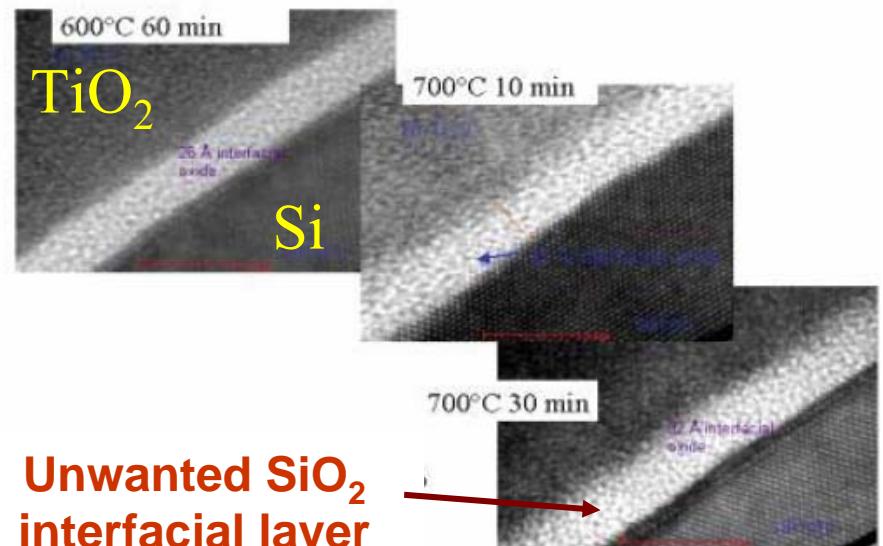
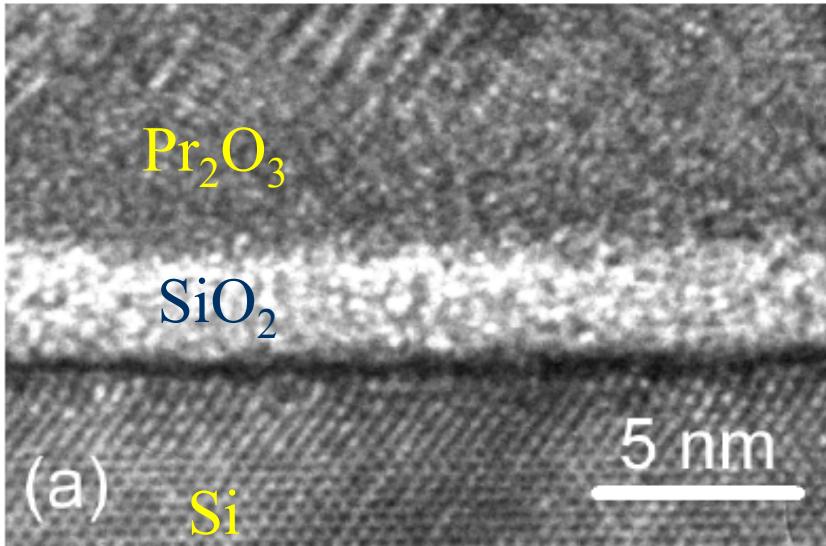
Type 2 is most important, e.g. in TFT transistors

### Problems to be solved: Interfaces reactions, phase formation, diffusion

## Selected examples

### High k dielectrics on Si: $\text{Pr}_2\text{O}_3$ , $\text{TaO}_x$ , $\text{HfO}_2$ , $\text{TiO}_2$

Problem: Interface  $\text{SiO}_2$  formation, crystallinity, phases, interface trap density



**Fig. 3:** Cross-sectional TEM images of a  $\text{Pr}_2\text{O}_3$  film grown on  $\text{Si}(001)$  without (a) and with (b) a 100 nm thick poly-Si capping layer (grown without leaving the vacuum). The bright amorphous interfacial layer for the film without capping can be attributed to a  $\text{SiO}_x$  layer due to indiffused oxygen during the contact to air.

(Courtesy of B. Foran of SEMATECH)

Fissel, JVST B21 (2003) 1765

Osten et al, IWGI 2001, Tokyo

## Selected examples

### Diluted magnetic semiconductors: TM:ZnO, TM:GaN

C. LIU, F. YUN, H. MORKOC,  
JOURNAL OF MATERIALS SCIENCE: MATERIALS IN ELECTRONICS **16** (2005) 555– 597

V	Cr	Mn	Fe	Co	Ni	Cu
$4s^23d^3$	$4s^13d^5$	$4s^23d^5$	$4s^23d^6$	$4s^23d^7$	$4s^23d^8$	$4s^13d^{10}$
4s						
3d						
3p <sup>6</sup>						
3s <sup>2</sup>						
2p <sup>6</sup>						
2s <sup>2</sup>						
1s <sup>2</sup>						

Electronic configurations of 3d and 4s states

TABLE I Expected oxidation and charge state of some candidate transition metals in ZnO and GaN. Neutral state is referred as the same charge state as that of the cation in the host material, such that  $Mn^{2+}$  is the neutral state in ZnO, whereas  $Mn^{3+}$  is the neutral state in GaN. The electron configuration for each charge state is given in the first row (after T. Graf *et al.*, ref. 46)

ZnO	$3d^3$	$3d^4$	$3d^5$	$3d^6$	GaN
Acceptor (negative charge)					$Cr^+$ $Mn^+$
Neutral			$Cr^{2+}$	$Mn^{2+}$	$Fe^{2+}$
Donor (positive charge)	$Cr^{3+}$	$Mn^{3+}$	$Fe^{3+}$		Acceptor
Double donor (2 <sup>+</sup> charge)	$Mn^{4+}$	$Fe^{4+}$			Neutral Donor

### TM atoms: Magnetic impurities with neutral, donor or acceptor character

## Selected examples

### Diluted magnetic semiconductors: TM:ZnO ; TM:GaN

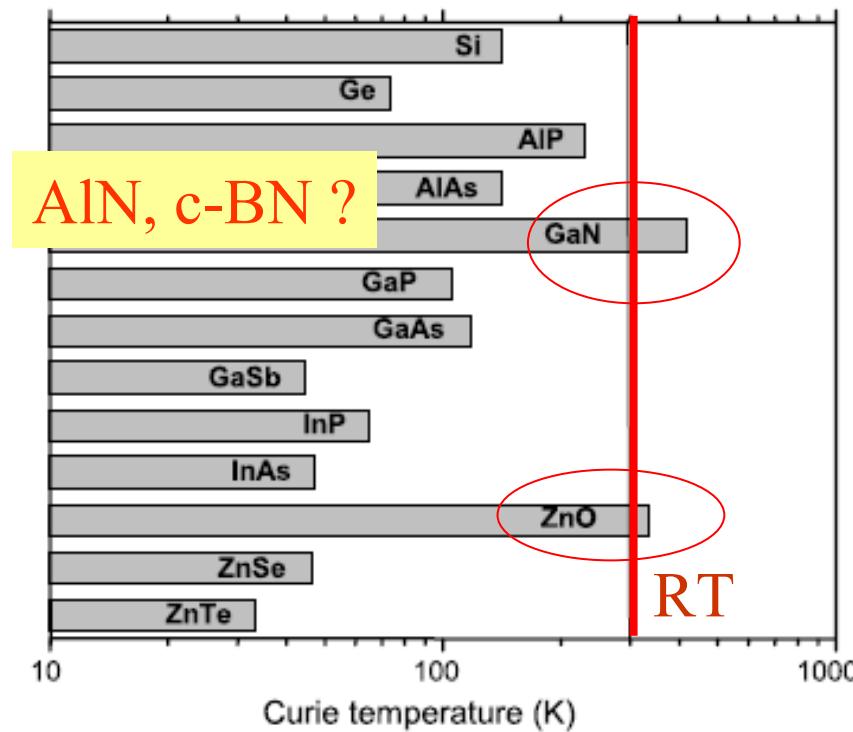


Figure 3 Predicted Curie temperatures as a function of the band gap. Computed values of the Curie temperature  $T_C$  for various  $p$ -type semiconductors containing 5% of Mn and  $3.5 \times 10^{20}$  holes per  $\text{cm}^3$ . (Reprinted with permission from ref. 3.)

- Required dopant concentration: ~ 5at.%
- No segregation and cluster formation

One of several models.....

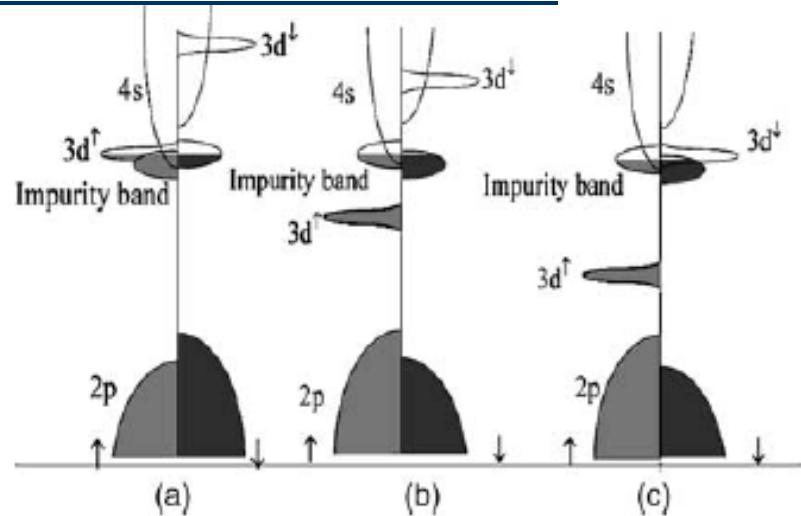
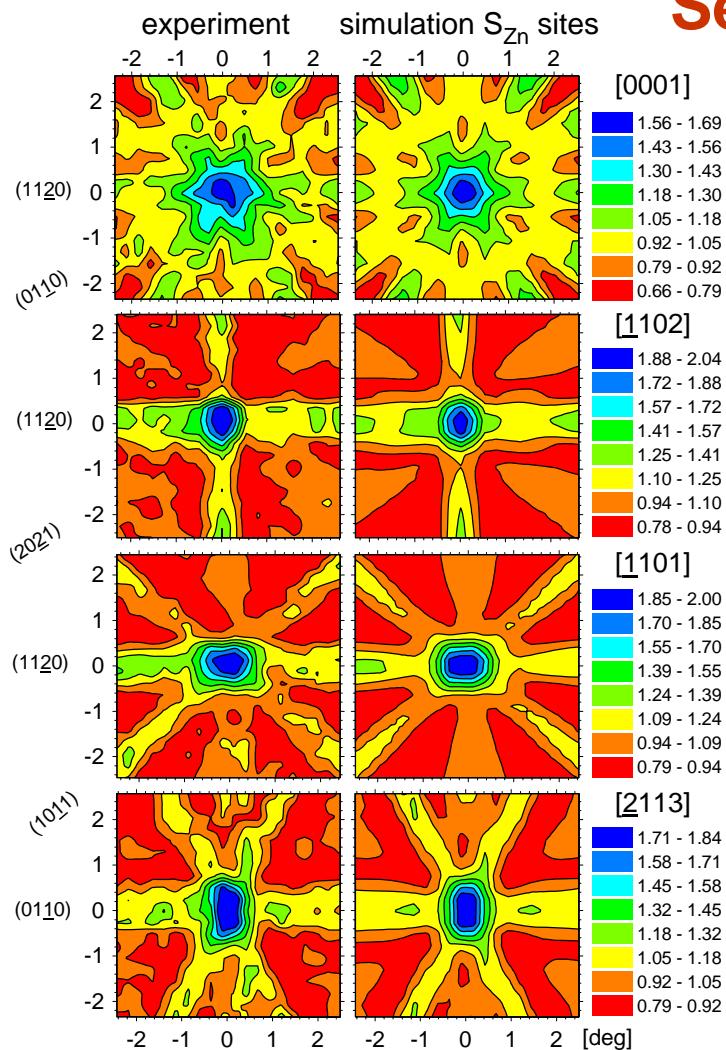


Figure 8 Schematic density of states for (a) TM = Ti, (b) TM = Mn, and (c) TM = Co. The Fermi level lies in a spin-split donor impurity band (after ref. 85). Venkatesan *et al.*



## Selected examples

### Recent EC studies on: Fe:ZnO

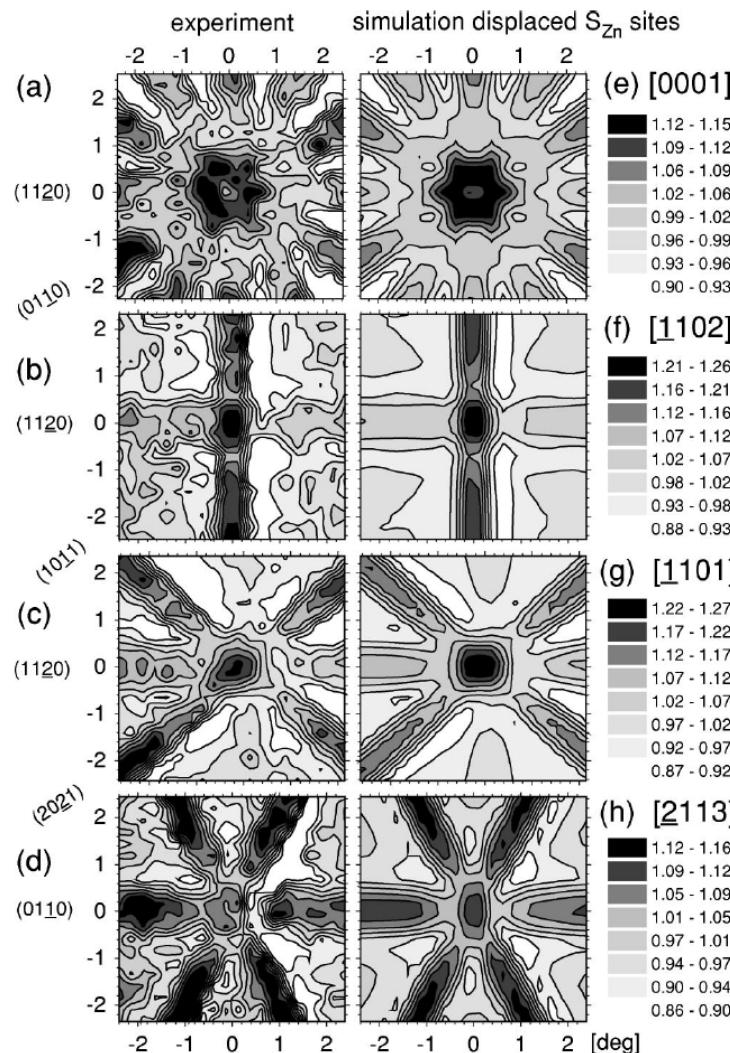
Wahl et al., Appl. Phys. Lett 85 (2004) 4899

<sup>59</sup>Mn/<sup>59</sup>Fe( $t_{1/2} = 44.6$  d), c < 100 ppm

Fe on substitutional Zn sites  
with rms displacement < 0.01 nm

To do: EC studies after doping with stable  
TM elements up to c ~ 5 at.%

## Selected examples



### Recent EC studies on: Cu:ZnO

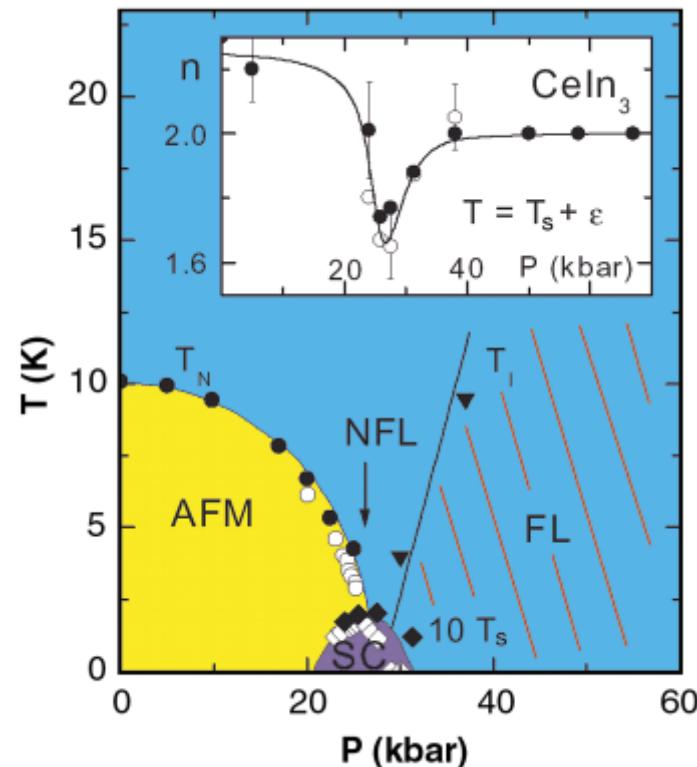
Wahl et al., Physical review B **69**, (2004) 012102

$^{67}\text{Cu}$  ( $t_{1/2} = 61.9$  h),  $c < 100$  ppm

Near substitutional Cu with rms displacement of about 0.045 nm

## Selected examples

### Heavy fermion systems



( $T$ ,  $P$ ) phase diagram of the anti-ferromagnet CeIn<sub>3</sub>.  $T_N$  and  $T_I$  are respectively the Néel temperature and the crossover temperature to the FL regime. The inset shows the pressure variation of the exponent  $n$  derived from the low temperature fitting of the electrical resistivity,  $\rho = \rho_0 + A_n T^n$ . NFL behavior ( $n \neq 2$ ) is observed just at  $P_c$ .

### Recent TDPAC studies:

Cottenier, Phys. Rev. B 63, 195103 (2001)

Carbonari, Hyp. Int 2001

Tulapurkar, Hyp. Int 1999

J.P. Sanchez , CEA-Grenoble, France

## Summary

- **Unique features of nuclear probes for solid state studies**
  - Extraordinary good sensitivity and selectivity  
*(not achievable with synchrotron radiation resonant scattering)*
  - Local probes on a scale of interatomic distances and better
  - Ion implantation provides control of concentration and depth distribution
- **Enhanced efficiency due to technical developments**
  - Highly efficient detectors, Imaging detectors,
  - Fast Digital data acquisition
  - Extended spectral range
  - Quantitative theoretical modelling of complex microstructures
- **Manyfold unexplored areas of research for radioactive probe techniques exist**